



Built on PMP20122RevB PCB

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Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 9/8/2016
TID #: TID	Project Title: UCC28710 High-side Buck Converter	
Number: PMP20495	Rev: A	Sheet Title: 90VAC- 150VAC to 12V/16W
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 1
Drawn By: Sheng-Yang Yu	File: PMP20122_RevB.SchDoc	Size: B
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